PNA4603H

Bipolar integrated circuit with photodetection functions

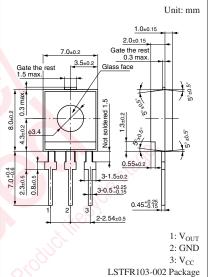
For brightness control systems

Features

- Wavelength characteristics close to human visual sensitivity
- External parts not required
- Good output voltage linearity with respect to incident illuminance

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Collector supply voltage	V _{CC}	7	V
Power dissipation	P _D	200	mW
Operating ambient temperature	T _{opr}	-20 to $+75$	°C
Storage temperature	T _{stg}	-40 to +100	°C



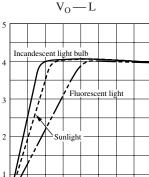
Electrical-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$, $V_{CC} = 5 V^{\perp}$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector supply voltage	V _{CC}	She Chi	4.5	5.0	5.5	V
Supply current	I _{CC}	V _{CC} = 5.25 V	0.5	1.0	1.5	mA
Output voltage	V _{OFF}	$L = 0 lx, V_{CC} = 5.0 V$	0.1	0.5	0.8	V
	V ₀₁ *1	$L = 10 lx, V_{CC} = 5.0 V$	2.0	2.7	3.4	
	V ₀₂ *1	$L = 800 lx, V_{CC} = 5.0 V$	3.9	4.1	4.9	
	η	$V_{O1} - V_{OFF}$, $V_{CC} = 5.0$ V	1.65	1.90	3.30	
Voltage ripple *1, 2, 3	R ₀₁	L = 10 lx	0.0	0.8	1.2	V
	Unix 1	$V_{CC} = 5.0 V + 10 mV[p-p] (f = 120 Hz)$	∞	S		
Output impedance *3	Z		5.0	10.0	15.0	kΩ
Peak emission wavelength *3	λ_p		400	600	700	nm

Note) *1: The origin of light use a halogen lamp.

*2: Peak to peak value of output AC voltage.

*3: Design guaranteed.



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Illuminance L (lx)

60

Output voltage V₀ (V)

0 <mark>L</mark> 0

20



80

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